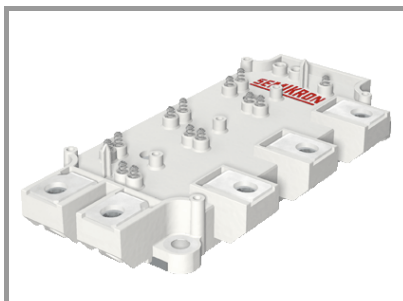


# SEMiX101GD126HDs



SEMiX<sup>®</sup>13

## Trench IGBT Modules

### SEMiX101GD126HDs

#### Preliminary Data

#### Features

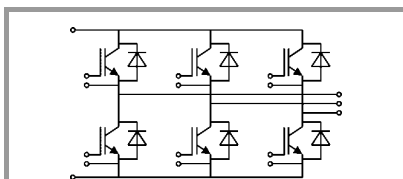
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$  with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

#### Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

#### Remarks

- Case temperatur limited to  $T_C=125^\circ\text{C}$  max.
- Not for new design



GD

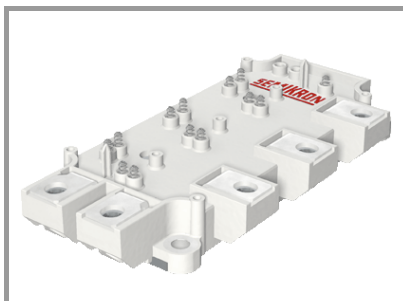
#### Absolute Maximum Ratings

| Symbol               | Conditions   | Values                   | Unit             |               |
|----------------------|--|--------------------------|------------------|---------------|
| <b>IGBT</b>          |  |                          |                  |               |
| $V_{CES}$            |  | 1200                     | V                |               |
| $I_C$                | $T_j = 150^\circ\text{C}$  | $T_c = 25^\circ\text{C}$ | 129              | A             |
|                      |  | $T_c = 80^\circ\text{C}$ | 91               | A             |
| $I_{CRM}$            | $I_{CRM} = 2 \times I_{Cnom}$  | 150                      | A                |               |
| $V_{GES}$            |  | -20 ... 20               | V                |               |
| $t_{psc}$            | $V_{CC} = 600\text{V}$<br>$V_{GE} \leq 20\text{V}$<br>$T_j = 125^\circ\text{C}$<br>$V_{CES} \leq 1200\text{V}$ |                          | 10               | $\mu\text{s}$ |
|                      |  |                          |                  |               |
| $T_j$                |  | -40 ... 150              | $^\circ\text{C}$ |               |
| <b>Inverse diode</b> |  |                          |                  |               |
| $I_F$                | $T_j = 150^\circ\text{C}$  | $T_c = 25^\circ\text{C}$ | 117              | A             |
|                      |  | $T_c = 80^\circ\text{C}$ | 81               | A             |
| $I_{FRM}$            | $I_{FRM} = 2 \times I_{Fnom}$  | 150                      | A                |               |
| $I_{FSM}$            | $t_p = 10\text{ms}$ , half sine wave, $T_j = 25^\circ\text{C}$   | 600                      | A                |               |
| $T_j$                |  | -40 ... 150              | $^\circ\text{C}$ |               |
| <b>Module</b>        |  |                          |                  |               |
| $I_{t(RMS)}$         |  | 600                      | A                |               |
| $T_{stg}$            |  | -40 ... 125              | $^\circ\text{C}$ |               |
| $V_{isol}$           | AC sinus 50Hz, $t = 60\text{s}$  | 4000                     | V                |               |

#### Characteristics

| Symbol        | Conditions  | min.                      | typ.  | max. | Unit             |
|---------------|---|---------------------------|-------|------|------------------|
| <b>IGBT</b>   |   |                           |       |      |                  |
| $V_{CE(sat)}$ | $I_{Cnom} = 75\text{A}$<br>$V_{GE} = 15\text{V}$<br>chiplevel | $T_j = 25^\circ\text{C}$  | 1.7   | 2.1  | V                |
|               |   | $T_j = 125^\circ\text{C}$ | 2.00  | 2.45 | V                |
| $V_{CE0}$     |   | $T_j = 25^\circ\text{C}$  | 1     | 1.2  | V                |
|               |   | $T_j = 125^\circ\text{C}$ | 0.9   | 1.1  | V                |
| $r_{CE}$      | $V_{GE} = 15\text{V}$   | $T_j = 25^\circ\text{C}$  | 9.3   | 12.0 | $\text{m}\Omega$ |
|               |   | $T_j = 125^\circ\text{C}$ | 14.7  | 18.0 | $\text{m}\Omega$ |
| $V_{GE(th)}$  | $V_{GE}=V_{CE}$ , $I_C = 3\text{mA}$                          | 5                         | 5.8   | 6.5  | V                |
| $I_{CES}$     | $V_{GE} = 0\text{V}$<br>$V_{CE} = 1200\text{V}$               | $T_j = 25^\circ\text{C}$  | 0.1   | 0.3  | mA               |
|               |   | $T_j = 125^\circ\text{C}$ |       |      | mA               |
| $C_{ies}$     | $V_{CE} = 25\text{V}$   |                           | 5.3   |      | nF               |
| $C_{oes}$     | $V_{GE} = 0\text{V}$  |                           | 0.28  |      | nF               |
| $C_{res}$     |   |                           | 0.24  |      | nF               |
| $Q_G$         | $V_{GE} = -8 \text{ V} \dots +15 \text{ V}$                   |                           | 600   |      | nC               |
| $R_{Gint}$    | $T_j = 25^\circ\text{C}$                                      |                           | 10.00 |      | $\Omega$         |
| $t_{d(on)}$   | $V_{CC} = 600\text{V}$  |                           | 225   |      | ns               |
| $t_r$         | $I_{Cnom} = 75\text{A}$                                       |                           | 40    |      | ns               |
| $E_{on}$      | $T_j = 125^\circ\text{C}$                                     |                           | 10    |      | mJ               |
| $t_{d(off)}$  | $R_{G on} = 2\Omega$<br>$R_{G off} = 2\Omega$                 |                           | 470   |      | ns               |
|               |   |                           |       |      |                  |
| $t_f$         |   |                           | 85    |      | ns               |
| $E_{off}$     |   |                           | 11    |      | mJ               |
| $R_{th(j-c)}$ | per IGBT  |                           |       | 0.27 | K/W              |

# SEMiX101GD126HDs



SEMiX<sup>®</sup>13

## Trench IGBT Modules

### SEMiX101GD126HDs

#### Preliminary Data

#### Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$  with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

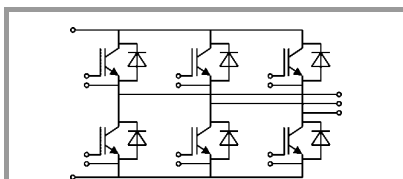
#### Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

#### Remarks

- Case temperatur limited to  $T_C=125^\circ\text{C}$  max.
- Not for new design

| Characteristics           |  |                           |      |                    |      |               |
|---------------------------|--|---------------------------|------|--------------------|------|---------------|
| Symbol                    | Conditions   |                           | min. | typ.               | max. | Unit          |
| <b>Inverse diode</b>      |  |                           |      |                    |      |               |
| $V_F = V_{EC}$            | $I_{Fnom} = 75\text{A}$<br>$V_{GE} = 0\text{V}$<br>chipelevel          | $T_j = 25^\circ\text{C}$  |      | 1.6                | 1.8  | V             |
|                           |  | $T_j = 125^\circ\text{C}$ |      | 1.6                | 1.8  | V             |
| $V_{F0}$                  |  | $T_j = 25^\circ\text{C}$  | 0.9  | 1                  | 1.1  | V             |
|                           |  | $T_j = 125^\circ\text{C}$ | 0.7  | 0.8                | 0.9  | V             |
| $r_F$                     |  | $T_j = 25^\circ\text{C}$  | 6.7  | 8.0                | 9.3  | m $\Omega$    |
|                           |  | $T_j = 125^\circ\text{C}$ | 9.3  | 10.7               | 12.0 | m $\Omega$    |
| $I_{RRM}$                 | $I_{Fnom} = 75\text{A}$  | $T_j = 125^\circ\text{C}$ |      | 97                 |      | A             |
| $Q_{rr}$                  | $di/dt_{off} = 2240\text{A}/\mu\text{s}$                               | $T_j = 125^\circ\text{C}$ |      | 20                 |      | $\mu\text{C}$ |
| $E_{rr}$                  | $V_{GE} = -15\text{V}$<br>$V_{CC} = 600\text{V}$                       | $T_j = 125^\circ\text{C}$ |      | 9                  |      | mJ            |
| $R_{th(j-c)D}$            | per diode  |                           |      |                    | 0.46 | K/W           |
| <b>Module</b>             |  |                           |      |                    |      |               |
| $L_{CE}$                  |  |                           |      | 20                 |      | nH            |
| $R_{CC+EE}$               | res., terminal-chip  | $T_C = 25^\circ\text{C}$  |      | 0.7                |      | m $\Omega$    |
|                           |  | $T_C = 125^\circ\text{C}$ |      | 1                  |      | m $\Omega$    |
| $R_{th(c-s)}$             | per module   |                           |      | 0.04               |      | K/W           |
| $M_s$                     | to heat sink (M5)  |                           | 3    |                    | 5    | Nm            |
| $M_t$                     | to terminals (M6)  |                           | 2.5  |                    | 5    | Nm            |
| w                         |  |                           |      |                    | 350  | g             |
| <b>Temperature sensor</b> |  |                           |      |                    |      |               |
| $R_{100}$                 | $T_C=100^\circ\text{C}$ ( $R_{25}=5\text{ k}\Omega$ )                  |                           |      | 0,493<br>$\pm 5\%$ |      | k $\Omega$    |
| $B_{100/125}$             | $R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$ ;<br>$T[\text{K}]$ ; |                           |      | 3550<br>$\pm 2\%$  |      | K             |



GD

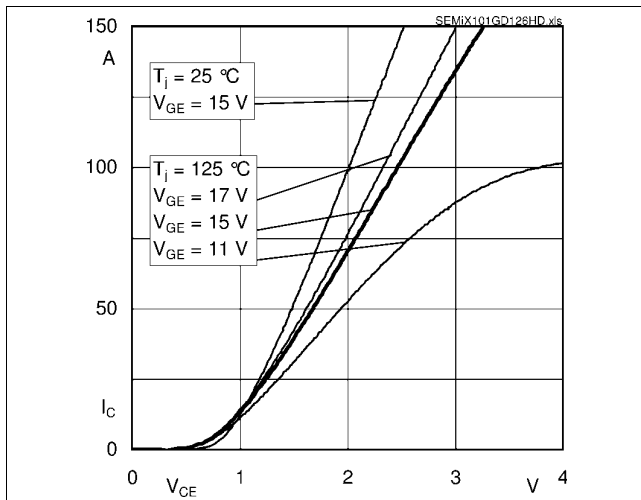


Fig. 1 Typ. output characteristic, inclusive  $R_{CC} + E_{E'}$

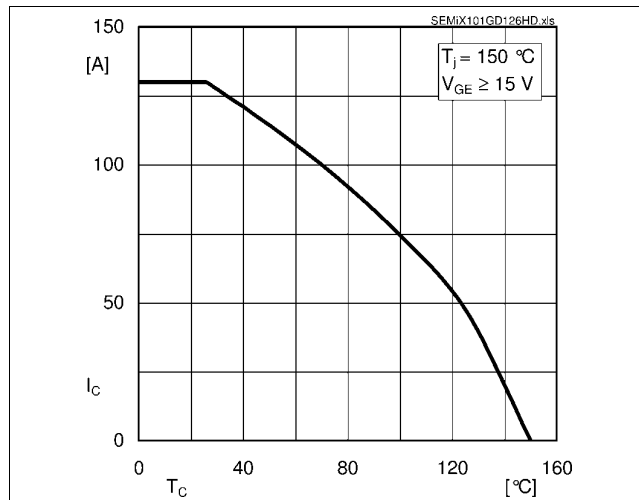


Fig. 2 Rated current vs. temperature  $I_c = f(T_c)$

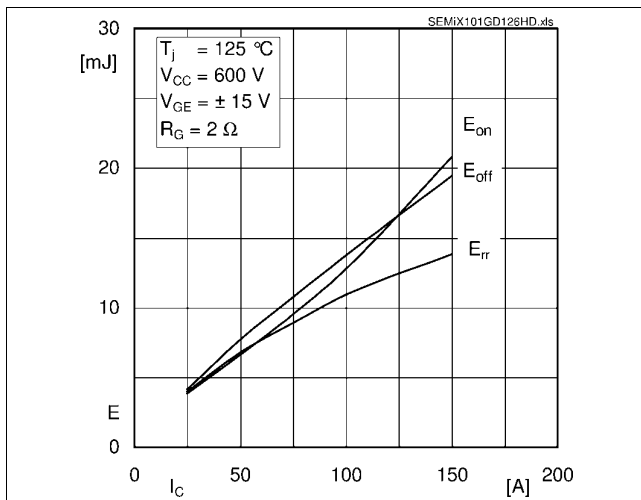


Fig. 3 Typ. turn-on /-off energy =  $f(I_c)$

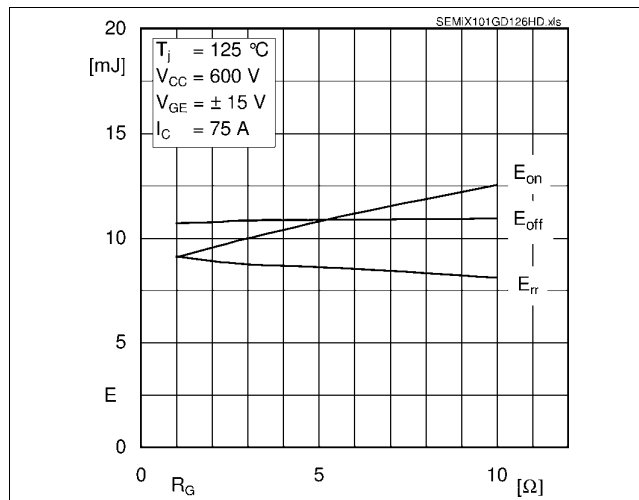


Fig. 4 Typ. turn-on /-off energy =  $f(R_g)$

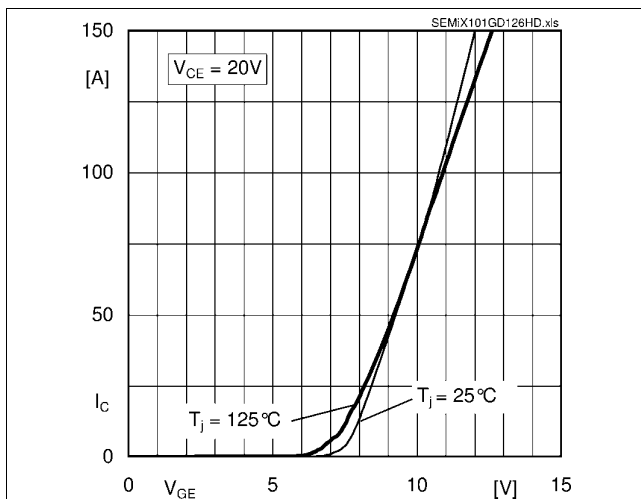


Fig. 5 Typ. transfer characteristic

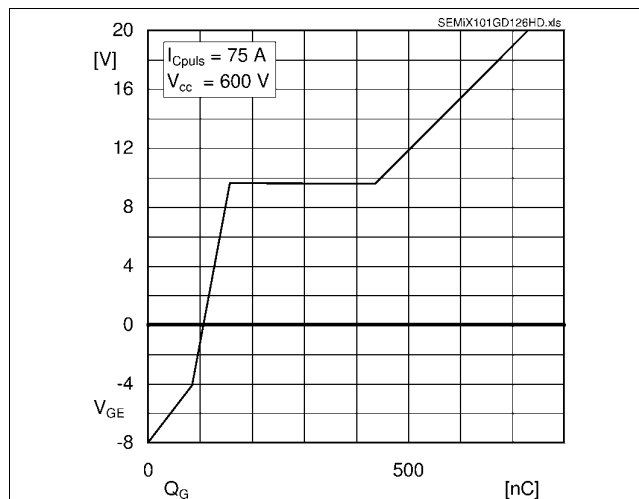
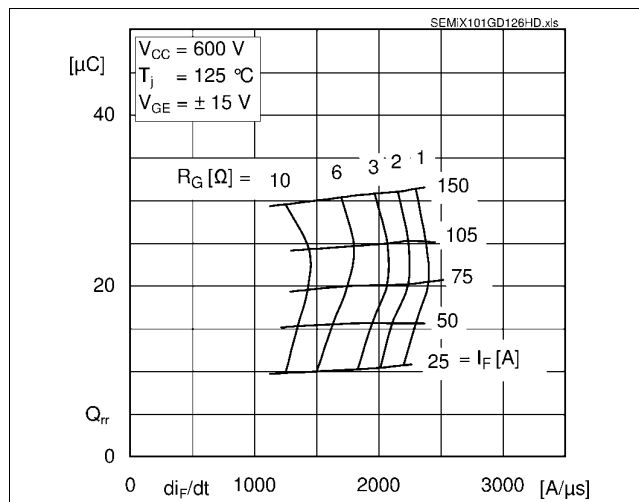
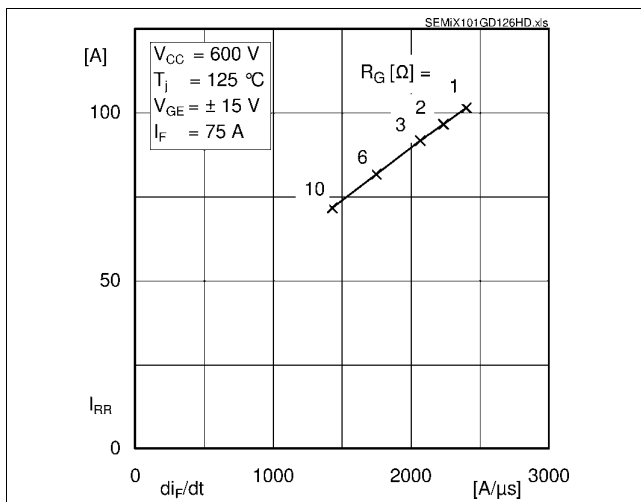
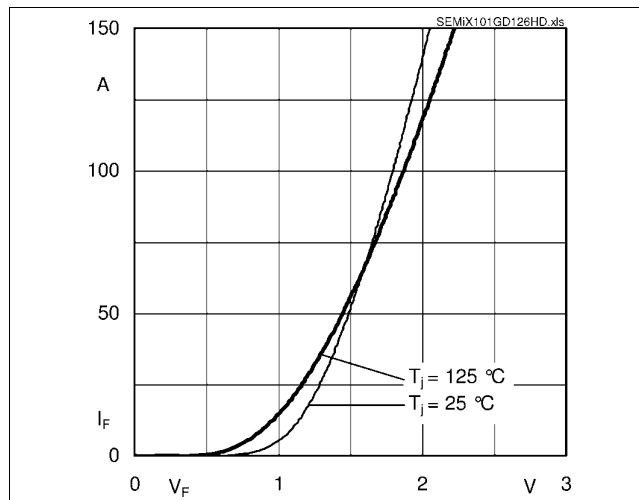
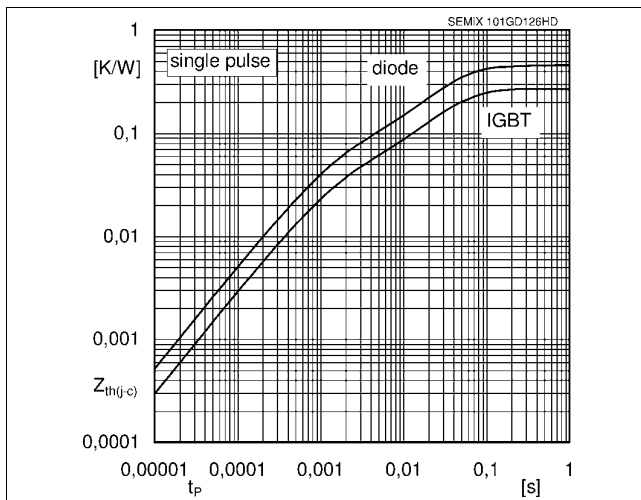
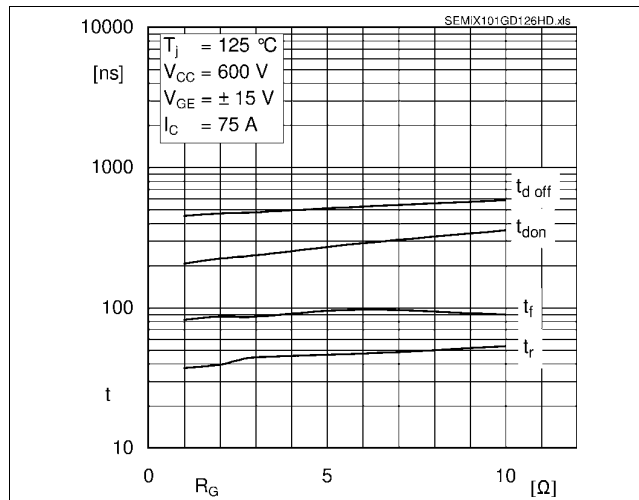
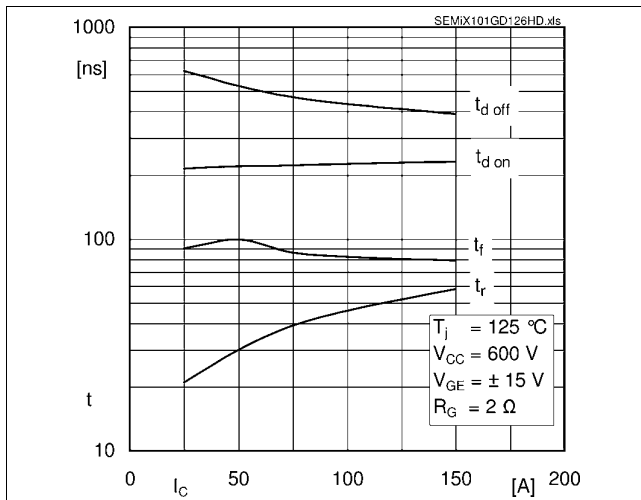
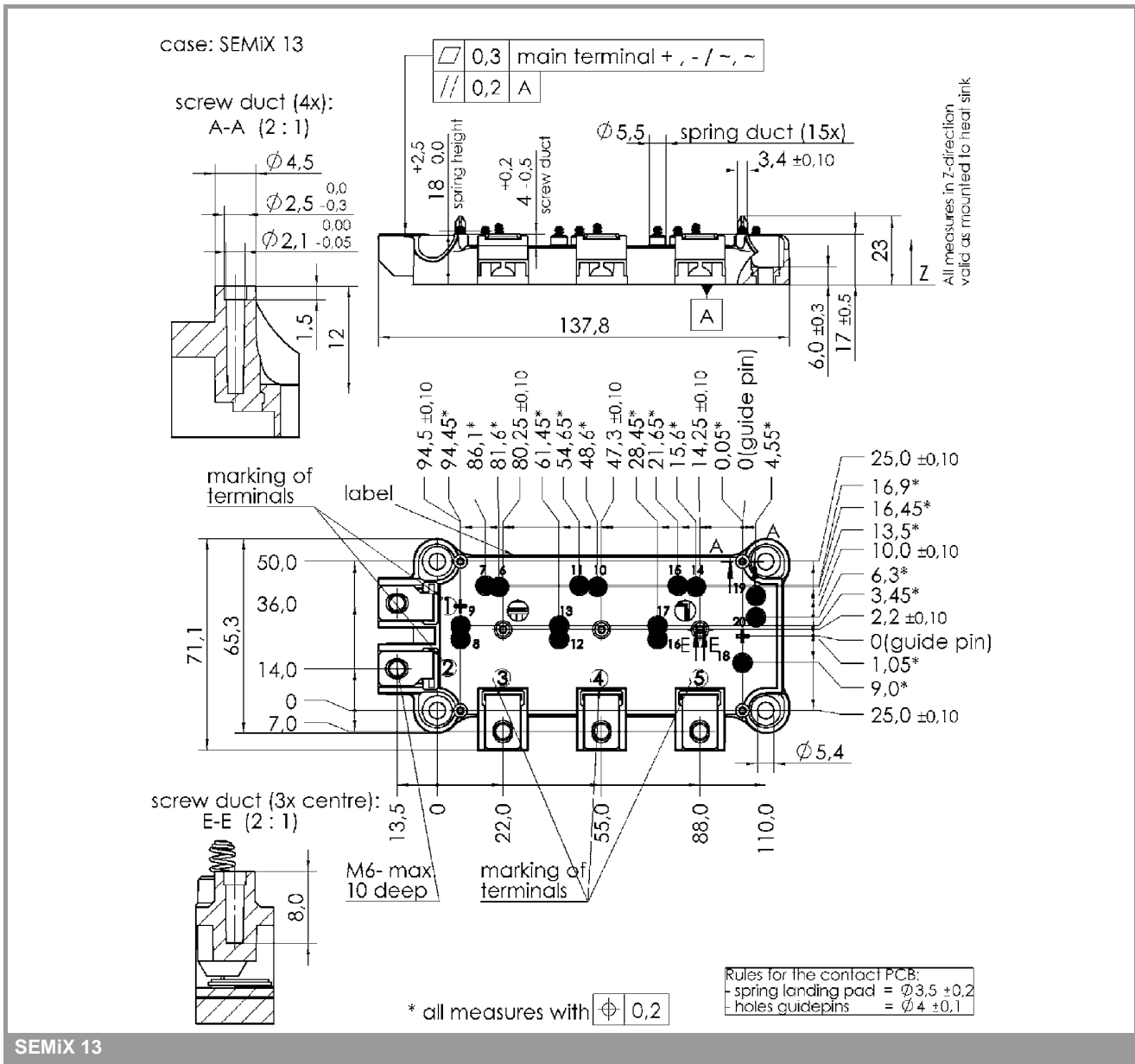


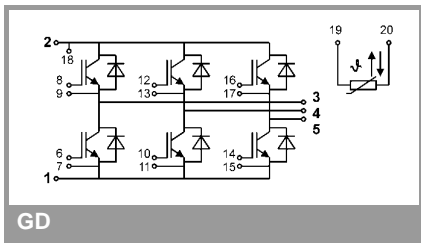
Fig. 6 Typ. gate charge characteristic



# SEMIX101GD126HDs



SEMIX 13



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

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